Surface Mount Red / Green LED 3.5mm × 2.8mm multicomp PRO



Features

- Dimensions:3.5mm × 2.8mm × 1.9mm.
- Wide Viewing Angle.

Applications

- Automotive: Backlighting in dashboard and switch.
- · Telecommunication: Indicator and Backlighting in telephone and fax.
- · Flat Backlight for LCD switch and symbol.

Optical Properties

Chip		Lens Colour
Material	Emitted Colour	
(InGaAIP)	Red	Water Clear
(InGaAIP)	Green	

Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Red	Green	Unit
Power Dissipation	Po	62		mW
Forward Current	lF	25 m		mA
Peak Forward Current*1	IFP	100 m		mA
Reverse Voltage	VR	5 V		V
Operating Temperature	Topr	-40°C To +85°C		
Storage Temperature	Tstg	-40°C To +85°C		;

Notes:

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Device	Min.	Тур.	Max	Unit	Test Conditions
Forward Voltage	VF		1.8 1.8	_	2.6 2.6	V	IF=20mA
Reverse Current	lr		_	_	10	μA	VR=5V
Dominate Wavelength	λп	Red Green	617 568	_	629 576	nm	
Luminous Intensity	lv		225 100	_	500 225	mcd	IF=20mA
Viewing Angle	2θ1/2		_	120	_	Deg.	

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or chromaticity), the typical accuracy of the sorting process is as follows:

Wavelength: ±1nm
 Luminous Intensity: ±15%
 Forward Voltage: ±0.1V

Newark.com/multicomp-pro Farnell.com/multicomp-pro sg.element14.com/b/multicomp-pro



RoHS

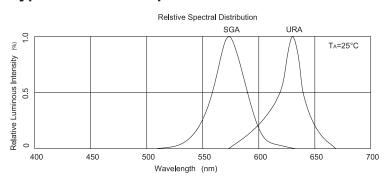
Compliant

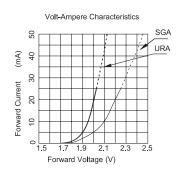
^{*1:} Pulse width≤0.1ms, Duty cycle≤1/10

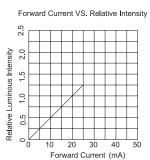
Surface Mount Red / Green LED 3.5mm × 2.8mm

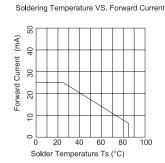
multicomp PRO

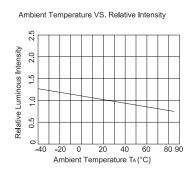
Typical Electrical/Optical Characteristics Curves

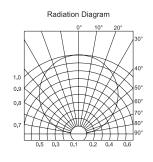




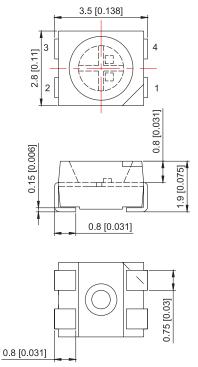






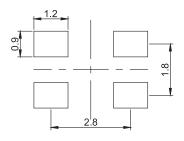


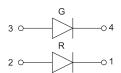
Package Dimensions



Dimensions: Millimetres (Inches)

Recommended soldering pattern





Notes:

- 1. All dimensions are in millimetres.
- 2. Tolerance is ±0.15 unless otherwise noted.
- 3. Specifications are subject to change without notice.

Newark.com/multicomp-pro Farnell.com/multicomp-pro sg.element14.com/b/multicomp-pro



Surface Mount Red / Green LED 3.5mm × 2.8mm

multicomp PRO

VF Rank

Red

Rank	VF(V)		Conditions	
Kalik	Min	Max	Conditions	
В	1.8	2		
С	2	2.2	F=20mA	
D	2.2	2.4	F-ZUIIA	
E	2.4	2.6		

Tolerance:±0.1V

Green

Rank	VF	(V)	Conditions	
Kank	Min	Max		
В	1.8	2		
С	2	2.2	F=20mA	
D	2.2	2.4	F-ZUIIA	
E	2.4	2.6		

λD Rank

Red

Rank	λD(nm)		Conditions	
Kalik	Min	Max	Conditions	
5	617	621		
6	621	625	IF=20mA	
7	625	629		

Tolerance:±1nm

Green

Rank	λD(nm)	Conditions	
Kalik	Min	Max		
9B	568	570		
1C	570	572	IF=20mA	
2C	572	574	IF-ZUIIA	
3C	574	576		

IV Rank

Red

Rank	IV(mcd)		Conditions	
Kalik	Min	Max	Conditions	
R	225	295		
S	295	385	IF=20mA	
Т	385	500		

Tolerance:±15%

Green

Rank	IV(mcd)		Conditions	
Kalik	Min	Max	Conditions	
S	100	130		
Т	130	170	IF=20mA	
U	170	225		

Reliability Test Items and Conditions

Test Itim	Reference	Test Conditions	Time	Quantity	Criterion
Thermal Shock	JIS-C7021 A-4	100°C±5°C 15min ↓↑ -40°C±5°C 15min	200 cycles		
High Temperature Storage	JEITA ED- 4701 200 201	Ta=100°C			
Low Temperature Storage	JEITA ED- 4701 200 202	Ta=-40°C			
High Temperature High Humidity Storage	JIS-C7021 B-11	Ta=85, RH=85%		22	0/22
Resistance to Soldering Heat	GB/T 4937	Tsol*=(260±5)°C 10secs.	1000 hrs.		
Life Test	JESD22 A409	Ta=25°C±5°C IF=20mA			
High Temperature Life Test	JESD22-A108	Ts=55°C±5°C IF=20mA			

Note:Tsol-Temperature of tin liquid.

Newark.com/multicomp-pro Farnell.com/multicomp-pro sg.element14.com/b/multicomp-pro

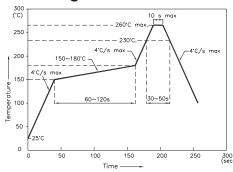


Surface Mount Red / Green LED 3.5mm × 2.8mm multicomp PRO

lto m	Item Symbol Test Conditions		Failure	Criteria
item	Symbol	rest Conditions	MIN.	MAX.
Forward Voltage	VF(V)	IF=20mA	-	U.S.L*1.1
Reverse Current	IR(uA)	VR=5V	-	10uA
Luminous Flux	IV(LM)	IF=20mA	L.S.L*0.7	-

Note:1.USL:Upper Specification Level 2.LSL:Lower Specification Level

Soldering Profile

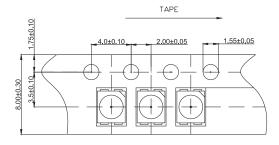


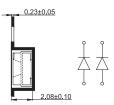
Recommend the reflow temperature 245°C (±5°C) The maximum soldering temperature should be limited to 260°C. Reflow soldering should not be done more than two times.

Stress on the LEDs should be avoided during heating in soldering process.

After soldering, do not deal with the product before its temperature drop down to room temperature.

Tape Specifications





Part Number Table

Description	Part Number
SMD LED, 3528, Red / Green, 500/225mcd, 120°	MP005919

Dimensions: Millimetres

Important Notice: This data sheet and its contents (the "Information") belong to the members of the AVNET group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information is subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp Pro is the registered trademark of Premier Farnell Limited 2019.

Newark.com/multicomp-pro Farnell.com/multicomp-pro sg.element14.com/b/multicomp-pro

